## IN THE CLAIMS:

- 1.-8. (Canceled)
- 9. (Currently Amended) A method comprising:

positioning a substrate and a light source assembly adjacent to each other, wherein the light source assembly is configured to generate light for reading or writing data to an optical data storage media, wherein the light source assembly including comprises a first and second alignment marks, wherein the substrate including comprises first and second alignment marks, said alignment marks of said light source assembly configured to not overlap said alignment marks of said substrate;

adjusting a position of the light source assembly with respect to the substrate until a line extending between the first and second alignment marks of the light source assembly is substantially parallel to a line extending between the first and second alignment marks of the substrate;

creating a rigid connection between the light source assembly and the substrate; and providing a first adhesive between the substrate and the light source assembly, said wherein creating the rigid connection including; comprises

activating the first adhesive to create a fixed bond between the substrate and the light source assembly;

providing a second adhesive between the substrate and an integrated circuit; adjusting a position of the integrated circuit with respect to the substrate; and activating the second adhesive to create a fixed bond between the integrated circuit and the substrate.

- 10. (Original) The method of claim 9 wherein the second adhesive is applied after the first adhesive is activated.
- 11. (Original) The method of claim 9 wherein the position of the integrated circuit is adjusted with respect to the substrate before the second adhesive is activated.
  - 12. (Currently Amended) A method comprising:

providing a first adhesive between a substrate and a light source, wherein the

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light source is configured to generate light for reading or writing data to an optical data storage media, wherein the substrate including comprises first and second alignment marks, wherein the light source including comprises first and second alignment marks, said alignment marks of said light source assembly configured to not overlap said alignment marks of said substrate;

adjusting a position of the light source with respect to the substrate until a line extending between the first and second alignment marks of the light source is substantially parallel to a line extending between the first and second alignment marks of the substrate;

activating the first adhesive to create a fixed bond between the substrate and the light source;

providing a second adhesive between the substrate and an integrated circuit; adjusting a position of the integrated circuit with respect to the substrate; activating the second adhesive to create a fixed bond between the integrated circuit and the substrate.

- 13. (Original) The method of claim 12 wherein the position of the light source is adjusted with respect to the substrate before the first adhesive is activated.
- 14. (Original) The method of claim 12 wherein the first adhesive is applied to the substrate.
- 15. (Original) The method of claim 12 wherein the first adhesive is a heat activated adhesive, and wherein activating the first adhesive comprises subjecting the first adhesive to heat generated by a heat source.
- 16. (Original) The method of claim 12 wherein the light source is configured to emit a light beam, wherein the line between the first and second alignment marks of the light source is substantially parallel to a direction at which the light beam is emitted from the light source.

17. (Original) The method of claim 12 wherein adjusting comprises concurrently viewing one of the first and second alignment marks of the light source with one of the first and second alignment marks of the substrate through a microscope.

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- 18. (Original) The method of claim 12 wherein adjusting comprises concurrently viewing one of the first and second alignment marks of the light source with a centerline of the substrate through a microscope, wherein the centerline extends between the first and second alignment marks of the substrate.
  - 19. (Canceled)
- 20. (Previously Presented) The method of claims 12 wherein the second adhesive is applied after the first adhesive is activated.
- 21. (Previously Presented) The method of claim 9 wherein the first adhesive is applied to a surface of the substrate.
- 22. (Previously Presented) The method of claim 9 wherein the first adhesive is a heat activated adhesive, and wherein activating the first adhesive comprises subjecting the first adhesive to heat generated by a heat source.
- 23. (Previously Presented) The method of claim 9 wherein the light source assembly comprises a light source configured to emit a light beam for reading or writing data to the optical data storage media, wherein the line between the first and second alignment marks of the light source assembly is substantially parallel to a direction at which the light beam is emitted from the light source.
- 24. (Previously Presented) The method of claim 9 wherein adjusting further comprises concurrently viewing one of the first and second alignment marks of the light source assembly with one of the first and second alignment marks of the substrate through a microscope.
- 25. (Previously Presented) The method of claim 9 wherein adjusting further comprises concurrently viewing one of the first and second alignment marks of the light source assembly with a centerline of the substrate through a microscope, wherein the centerline extends between the first and second alignment marks of the substrate.
- 26. (Previously Presented) The method of claim 9 wherein the substrate comprises a bond pad, wherein the first adhesive is applied to the first bond pad.

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Please add Claims 27-34.

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## 27. (New) A method comprising:

positioning a substrate and a light source assembly adjacent to each other, the light source assembly is configured to generate light for reading or writing data to an optical data storage media, the light source assembly including first and second alignment marks, the substrate including first and second alignment marks, said alignment marks of said light source assembly configured to not overlap said alignment marks of said substrate;

adjusting a position of the light source assembly with respect to the substrate until a line extending between the first and second alignment marks of the light source assembly is substantially parallel to a line extending between the first and second alignment marks of the substrate; and

creating a rigid connection between the light source assembly and the substrate.

- (New) The method of Claim 27 further comprising providing a first adhesive 28. between the substrate and the light source assembly, wherein creating the rigid connection comprises activating the first adhesive to create a fixed bond between the substrate and the light source assembly providing a first adhesive between the substrate and the light source assembly.
- (New) The method of claim 28 wherein the first adhesive is applied to a 29. surface of the substrate.
- (New) The method of claim 28 wherein the first adhesive is a heat activated 30. adhesive, and wherein activating the first adhesive comprises subjecting the first adhesive to heat generated by a heat source.
- (New) The method of claim 27 wherein the light source assembly comprises a 31. light source configured to emit a light beam for reading or writing data to the optical data storage media, wherein the line between the first and second alignment marks of the light source assembly is substantially parallel to a direction at which the light beam is emitted from the light source.
- (New) The method of claim 27 wherein adjusting further comprises 32. concurrently viewing one of the first and second alignment marks of the light source assembly with one of the first and second alignment marks of the substrate through a microscope.

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- 33. (New) The method of claim 27 wherein adjusting further comprises concurrently viewing one of the first and second alignment marks of the light source assembly with a centerline of the substrate through a microscope, wherein the centerline extends between the first and second alignment marks of the substrate.
- 34. (New) The method of claim 28 wherein the substrate comprises a bond pad, wherein the first adhesive is applied to the first bond pad.

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